

CHEMTRONICS®

Technical Data Sheet

TDS # 1020K

Ultrajet® Duster System

PRODUCT DESCRIPTION

Ultrajet® Duster System is a high pressure duster that cleans electronics without scratching delicate surfaces. This duster/cleaner is nonflammable, residue-free and won't scratch delicate surfaces.

- Filtered to 0.2 microns
- Nonflammable
- Leaves no residue
- High pressure for contamination control
- Nonabrasive
- Excellent material compatibility
- Penetrates hard to reach areas
- Contains no ozone depleting compounds

TYPICAL APPLICATIONS

Ultrajet® Duster System is engineered for all aspects of electronic equipment maintenance and is particularly suited for applications involving:

- Audio/Video Equipment
- Computers and Other Electronic Equipment
- Fax Machines
- Lab Instruments
- Photo Equipment
- Printed Circuit Boards
- Printers
- Surface Mount Devices

TYPICAL PRODUCT DATA AND PHYSICAL PROPERTIES

Boiling Point	-15.7°F
Vapor Density (air=1) @ 77°F	3.18
Solubility in Water @ 77°F F/1 atm	0.10% by weight
Specific Gravity (water = 1 @77°F)	1.21
Evaporation Rate (butyl acetate=1)	>1
Appearance	Clear, Colorless Liquified Gas
Odor	Slight Ethereal
Surface Tension (dynes/cm @77°F)	7.8
Flash Point (TCC)	None
Shelflife	5 years

COMPATIBILITY

Ultrajet® Duster System is generally compatible with most materials used in printed circuit board fabrication, including sensitive plastics and compounds. As with any duster/cleaner, compatibility must be determined on a non-critical area prior to use.

<u>Material</u>	<u>Compatibility</u>
Buna-N	Excellent
Graphite	Excellent
HDPE	Excellent
LDPE	Excellent
Lexan™	Excellent
Neoprene	Excellent
Cross-Linked PE	Excellent
Polyacrylate	Excellent
Polystyrene	Excellent
PVC	Excellent
Silicone Rubber	Excellent
Teflon™	Excellent
Viton™	Excellent

TECHNICAL & APPLICATION ASSISTANCE

Chemtronics® provides a technical hotline to answer your technical and application related questions. The toll free number is:
1-800-TECH-401.

ENVIRONMENTAL IMPACT DATA

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CFC	0.0%	VOC	0.0%
HCFC	0.0%	HFC	100.0%
CL Solv.	0.0%	ODP	0.0

CFC, HCFC, CL. SOLV., VOC, and HFC numbers shown are the content by weight. Ozone depletion potential (ODP) is determined in accordance with the Montreal Protocol and U.S. Clean Air Act of 1990. The ODP of this product is 0.0. It is the sum of the ODP of the substances that may contribute to the depletion of stratospheric ozone, based upon the weight of each substance in the product's formulation.

NOTE:

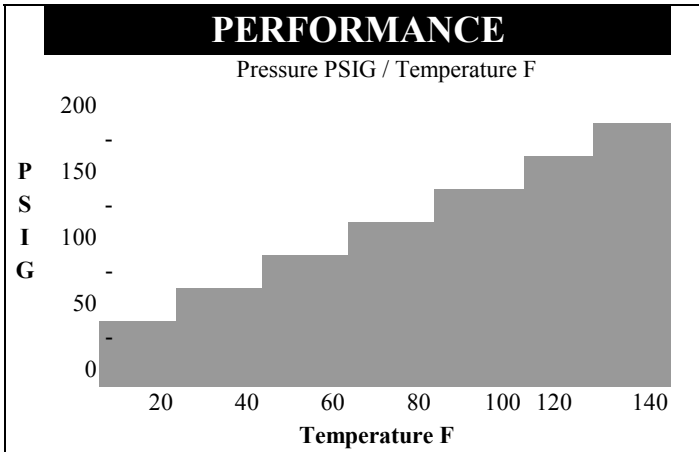
This information is believed to be accurate. It is intended for professional end users having the skills to evaluate and use the data properly. CHEMTRONICS® does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.

MANUFACTURED BY:

ITW CHEMTRONICS
8125 COBB CENTER DRIVE
KENNESAW, GA 30152
1-770-424-4888

REV. D (03/01)

DISTRIBUTED BY:



USAGE INSTRUCTIONS

For industrial use only.
Read MSDS carefully prior to use.
No special surface preparation is required prior to using Ultrajet® Duster System. Direct high pressure spray onto the area to be cleaned to remove dust, dirt and other contaminant. For optimum performance and pin point control, use with the attached extension tube.

AVAILABILITY

ES1020K 10 oz. Aerosol Kit
ES1020R 10 oz. Refill
ES710V Chrome Trigger Valve